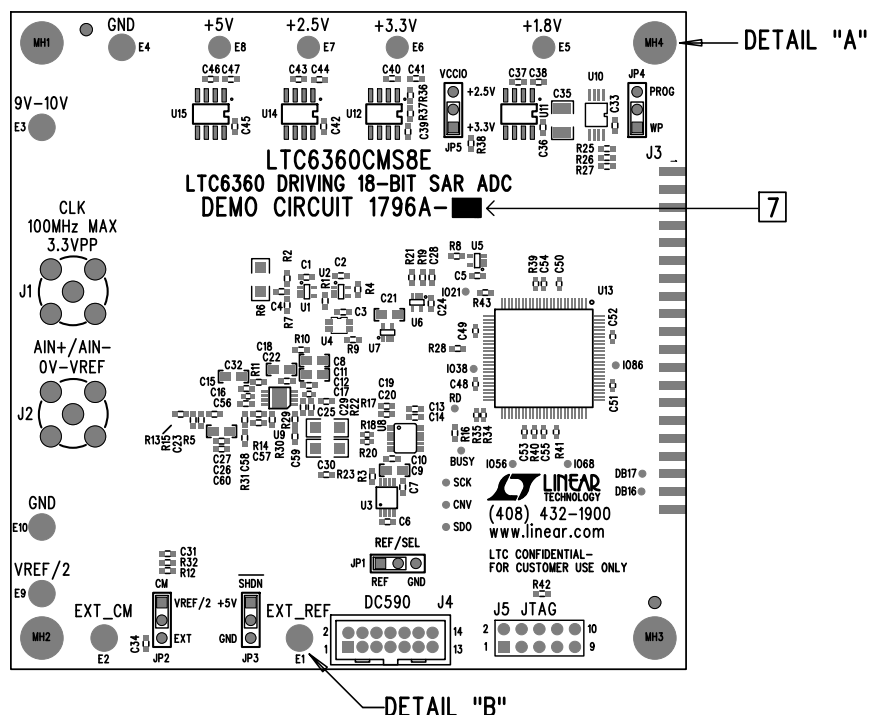
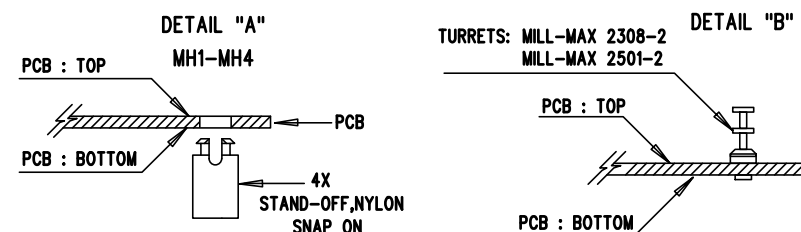


REVISION HISTORY			
ECO	REV	DESCRIPTION	APPR DATE
	2	PROD FABRICATION	ERJON Q. 12-9-11



## NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. INSTALL TURRETS, STAND-OFFS AS SHOWN BELOW:



7. MARK EACH ASSEMBLY TYPE WITH BLACK PERMANENT MARKER AS SHOWN IN TABLE BELOW:

ASSY	U8	Bits	Msp/s
-A	LTC2370CMS-16	16	2.0
-B	LTC2368CMS-16	16	1.0
-C	LTC2367CMS-16	16	0.5
-D	LTC2364CMS-16	16	0.25
-E	LTC2369CMS-18	18	1.6
-F	LTC2368CMS-18	18	1.0
-G	LTC2367CMS-18	18	0.5
-H	LTC2364CMS-18	18	0.25

APPROVALS		LINEAR TECHNOLOGY	
PCB DES. NC	APP ENG. ERJON Q.	1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL - FOR CUSTOMER USE ONLY	
		TITLE: TOP ASSEMBLY DRAWING: LTC6360 DRIVING 18-BIT SAR ADC	
SIZE	IC NO.	LTC6360CMS8E	REV.
N/A	DEMO CIRCUIT 1796A-A/H		2
SCALE = NONE		FILENAME: DC1796A-2.PCB	SHT 1 of 2